

S-5732 B Series

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125°C OPERATION HIGH-WITHSTAND VOLTAGE HIGH-SPEED UNIPOLAR DETECTION TYPE HALL EFFECT SWITCH IC

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This IC, developed by CMOS technology, is a unipolar detection type Hall effect switch IC with high-withstand voltage, highspeed detection and high-accuracy magnetic characteristics.

The output voltage changes when this IC detects the intensity level of magnetic flux density. Using this IC with a magnet makes it possible to detect the open / close and rotation status in various devices.

This IC includes an output current limit circuit.

This IC is available in various systems by using the insertion TO-92S package.

Due to its high-accuracy magnetic characteristics, this IC can make operation's dispersion in the system combined with magnet smaller.

ABLIC Inc. offers a "magnetic simulation service" that provides the ideal combination of magnets and our Hall ICs for customer systems. Our magnetism simulation service will reduce prototype production, development period and development costs. In addition, it will contribute to optimization of parts to realize high cost performance.

For more information regarding our magnetism simulation service, contact our sales office.

■ Features

 Pole detection*1: Detection of S pole Detection of N pole

 Output logic*1: Active "L" Active "H"

Output form^{*1}:

 Magnetic sensitivity*1: $B_{OP} = 6.0 \text{ mT typ.}$ • Chopping frequency: $f_C = 250 \text{ kHz typ.}$ • Output delay time: $t_D = 16.0 \, \mu s \, typ.$

• Power supply voltage range:

• Built-in regulator

• Built-in output current limit circuit

• Operation temperature range:

• Lead-free (Sn 100%), halogen-free

*1. The option can be selected.

■ Applications

- Home appliance
- DC brushless motor
- Housing equipment
- · Industrial equipment

Packages

- TO-92S (Straight)
- TO-92S (Forming)

Nch open-drain output

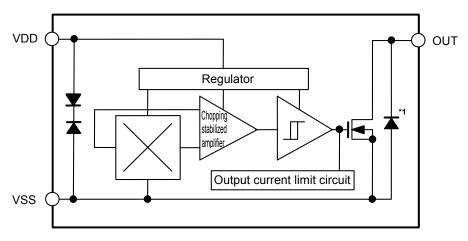
Nch driver + built-in pull-up resistor

 $B_{OP} = 3.0 \text{ mT typ.}$ $V_{DD} = 3.5 \text{ V to } 26.0 \text{ V}$

 $Ta = -40^{\circ}C \text{ to } +125^{\circ}C$

■ Block Diagrams

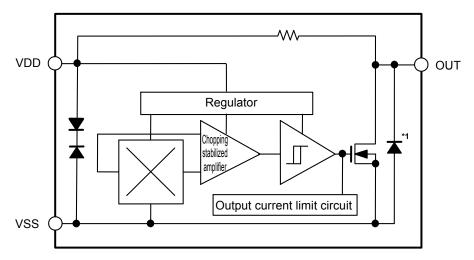
1. Nch open-drain output product



*1. Parasitic diode

Figure 1

2. Nch driver + built-in pull-up resistor product



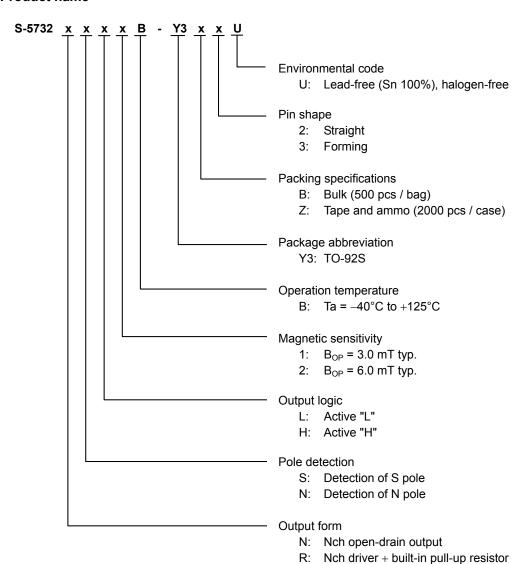
*1. Parasitic diode

Figure 2

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■ Product Name Structure

1. Product name



2. Packages

Table 1 Package Drawing Codes

Package Name		Dimension	Tape	Ammo Packing
TO 000 (Chroimht)	Bulk	VD002 A D CD	_	-
TO-92S (Straight)	Tape and ammo	YB003-A-P-SD	YC003-A-C-SD	YC003-A-Z-SD
TO 000 (Farming)	Bulk	VD002 D D CD	1	-
TO-92S (Forming)	Tape and ammo	YB003-B-P-SD	YC003-B-C-SD	YC003-B-Z-SD

3. Product name list

3. 1 TO-92S (Straight)

Table 2

Product Name*1	Output Form	Pole Detection	Output logic	Magnetic Sensitivity (B _{OP})
S-5732NSL1B-Y3n2U	Nch open-drain output	S pole	Active "L"	3.0 mT typ.
S-5732NSL2B-Y3n2U	Nch open-drain output	S pole	Active "L"	6.0 mT typ.
S-5732RSL1B-Y3n2U	Nch driver + built-in pull-up resistor	S pole	Active "L"	3.0 mT typ.
S-5732RSL2B-Y3n2U	Nch driver + built-in pull-up resistor	S pole	Active "L"	6.0 mT typ.

^{*1. &}quot;n" changes according to the packing specification as follows.

Remark Please contact our sales office for products other than the above.

3. 2 TO-92S (Forming)

Table 3

Product Name ^{*1} Output Form		Pole Detection	Output logic	Magnetic Sensitivity (B _{OP})	
S-5732NSL1B-Y3n3U	Nch open-drain output	S pole	Active "L"	3.0 mT typ.	

^{*1. &}quot;n" changes according to the packing specification as follows.

Remark Please contact our sales office for products other than the above.

■ Pin Configuration

1. TO-92S

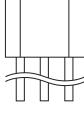




Figure 3

Table 4

Pin No.	Symbol	Description
1	VDD	Power supply pin
2	VSS	GND pin
3	OUT	Output pin

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B: Bulk, Z: Tape and ammo

B: Bulk, Z: Tape and ammo

■ Absolute Maximum Ratings

Table 5

(Ta = +25°C unless otherwise specified)

	Item	Symbol	Absolute Maximum Rating	Unit
Power supply voltage		V_{DD}	$V_{SS}-0.3$ to $V_{SS}+28.0$	V
Output current		I _{OUT}	20	mA
Output valtage	Nch open-drain output product	V _{OUT}	$V_{SS}-0.3$ to $V_{SS}+28.0$	V
Output voltage	Nch driver + built-in pull-up resistor product		$V_{SS} - 0.3$ to $V_{DD} + 0.3$	V
Operation ambient temperature		T _{opr}	-40 to +125	°C
Storage temperature		T _{stg}	-40 to +150	°C

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

■ Thermal Resistance Value

Table 6

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Junction-to-ambient thermal resistance	θ_{JA}	TO-92S	-	153 ^{*1}	-	°C/W

^{*1.} When not mounted on board

Remark Refer to "■ **Power Dissipation**" for details.

■ Electrical Characteristics

Table 7

(Ta = +25°C, V_{DD} = 12.0 V, V_{SS} = 0 V unless otherwise specified)

		(14 - 125 G, VDD - 12.5 V,	00 -	v driicc			Test
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Circuit
Power supply voltage	V_{DD}	_	3.5	12.0	26.0	V	_
Current consumption		Nch open-drain output product Average value	_	3.0	4.0	mA	1
Current consumption	I _{DD}	Nch driver + built-in pull-up resistor product Average value, V _{OUT} = "H"	_	3.0	4.0	mA	1
Output voltage	\	Nch open-drain output product Output transistor Nch, V _{OUT} = "L", I _{OUT} = 10 mA	_	-	0.4	V	2
Output voltage	V _{OUT}	Nch driver + built-in pull-up resistor product Output transistor Nch, V _{OUT} = "L", I _{OUT} = 10 mA	_	-	0.5	V	2
Output drop voltage	V _D	Nch driver + built-in pull-up resistor product V_{OUT} = "H", V_{D} = V_{DD} - V_{OUT}	_	-	20	mV	2
Leakage current	I _{LEAK}	Nch open-drain output product Output transistor Nch, V _{OUT} = "H" = 26.0 V	-	-	10	μА	3
Output limit current	I _{OM}	V _{OUT} = 12.0 V	22	_	70	mA	3
Output delay time	t _D	_	_	16.0	_	μS	_
Chopping frequency	f_C	_	_	250	_	kHz	_
Start up time	t _{PON}	_	_	30	_	μS	4
Output rise time	4	Nch open-drain output product $C = 20 \text{ pF}, R = 820 \Omega$	_	_	2.0	μS	5
	t _R	Nch driver + built-in pull-up resistor product C = 20 pF		_	6.0	μS	5
Output fall time	t _F	C = 20 pF, R = 820 Ω	_	_	2.0	μS	5
Pull-up resistor	R _L	Nch driver + built-in pull-up resistor product	7	10	13	kΩ	_

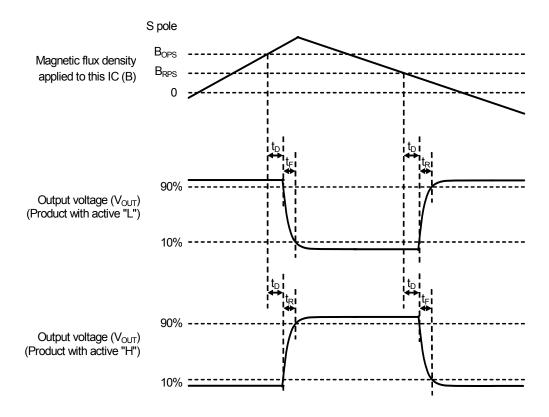


Figure 4 Operation Timing

■ Magnetic Characteristics

1. Product with S pole detection

1. 1 Product with $B_{OP} = 3.0 \text{ mT typ.}$

Table 8

(Ta = +25°C, V_{DD} = 12.0 V, V_{SS} = 0 V unless otherwise specified)

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Operation point*1	S pole	B _{OPS}	_	1.2	3.0	4.8	mT	4
Release point*2	S pole	B _{RPS}	_	0.8	2.0	3.6	mT	4
Hysteresis width*3	S pole	B _{HYSS}	$B_{HYSS} = B_{OPS} - B_{RPS}$	ı	1.0	I	mΤ	4

1. 2 Product with $B_{OP} = 6.0 \text{ mT typ.}$

Table 9

(Ta = +25°C, V_{DD} = 12.0 V, V_{SS} = 0 V unless otherwise specified)

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Operation point*1	S pole	B _{OPS}	_	3.0	6.0	9.0	mT	4
Release point*2	S pole	B _{RPS}	_	2.5	4.5	7.5	mT	4
Hysteresis width*3	S pole	B _{HYSS}	B _{HYSS} = B _{OPS} – B _{RPS}	_	1.5	_	mT	4

^{*1.} B_{OPN}, B_{OPS}: Operation points

 B_{OPN} and B_{OPS} are the values of magnetic flux density when the output voltage (V_{OUT}) changes after the magnetic flux density applied to this IC by the magnet (N pole or S pole) is increased (by moving the magnet closer).

Even when the magnetic flux density exceeds B_{OPN} or B_{OPS} , V_{OUT} retains the status.

*2. B_{RPN}, B_{RPS}: Release points

 B_{RPN} and B_{RPS} are the values of magnetic flux density when the output voltage (V_{OUT}) changes after the magnetic flux density applied to this IC by the magnet (N pole or S pole) is decreased (the magnet is moved further away).

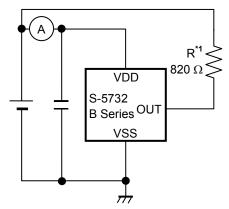
Even when the magnetic flux density falls below B_{RPN} or B_{RPS}, V_{OUT} retains the status.

*3. B_{HYSN} , B_{HYSS} : Hysteresis widths

B_{HYSN} and B_{HYSS} are the difference between B_{OPN} and B_{RPN}, and B_{OPS} and B_{RPS}, respectively.

Remark The unit of magnetic density mT can be converted by using the formula 1 mT = 10 Gauss.

■ Test Circuits



*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.

Figure 5 Test Circuit 1

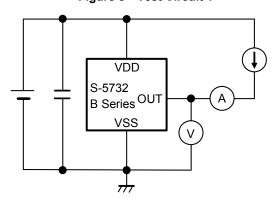


Figure 6 Test Circuit 2

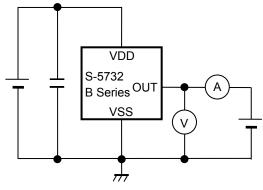
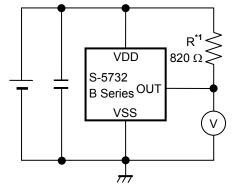
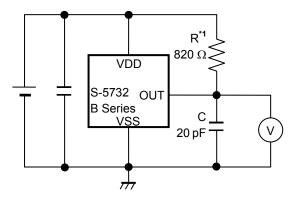


Figure 7 Test Circuit 3



*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.

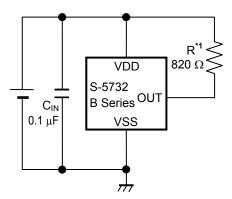
Figure 8 Test Circuit 4



*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.

Figure 9 Test Circuit 5

■ Standard Circuit



*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.

Figure 10

Caution The above connection diagram and constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constant.

■ Operation

1. Direction of applied magnetic flux

This IC detects the magnetic flux density which is vertical to the marking surface. **Figure 11** shows the direction in which magnetic flux is being applied.

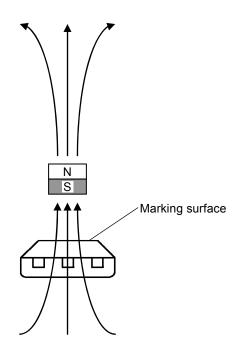


Figure 11

2. Position of Hall sensor

Figure 12 shows the position of Hall sensor.

The center of this Hall sensor is located in the area indicated by a circle, which is in the center of a package as described below.

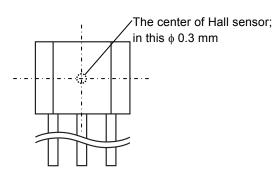


Figure 12

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3. Basic operation

This IC changes the output voltage (V_{OUT}) according to the level of the magnetic flux density (N pole or S pole) applied by a magnet.

The following explains the operation when the magnetism detection logic is active "L".

3. 1 Product with S pole detection

When the magnetic flux density of the S pole perpendicular to the marking surface exceeds the operation point (B_{OPS}) after the S pole of a magnet is moved closer to the marking surface of this IC, V_{OUT} changes from "H" to "L". When the S pole of a magnet is moved further away from the marking surface of this IC and the magnetic flux density is lower than the release point (B_{RPS}), V_{OUT} changes from "L" to "H".

Figure 13 shows the relationship between the magnetic flux density and V_{OUT}.

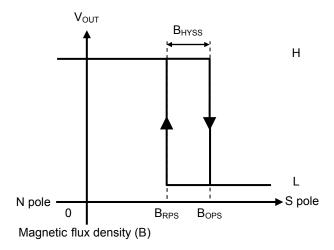


Figure 13

3. 2 Product with N pole detection

When the magnetic flux density of the N pole perpendicular to the marking surface exceeds the operation point (B_{OPN}) after the N pole of a magnet is moved closer to the marking surface of this IC, V_{OUT} changes from "H" to "L". When the N pole of a magnet is moved further away from the marking surface of this IC and the magnetic flux density of the N pole is lower than the release point (B_{RPN}) , V_{OUT} changes from "L" to "H".

Figure 14 shows the relationship between the magnetic flux density and V_{OUT} .

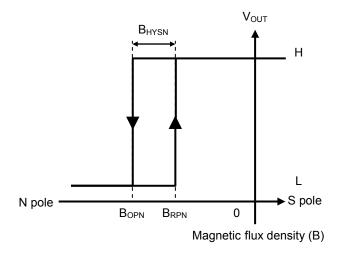


Figure 14

4. Timing chart

Figure 15 shows the operation timing at power-on.

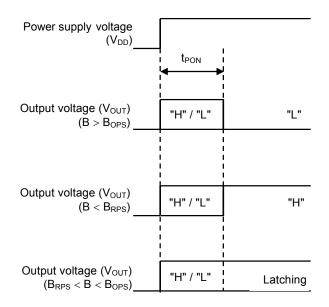
The initial output voltage at rising of power supply voltage (V_{DD}) is either "H" or "L".

In case of B > B_{OPS} (operation point) or B < B_{RPS} (release point) at the time when the start up time (t_{PON}) is passed after rising of V_{DD} , this IC outputs V_{OUT} according to the applied magnetic flux density.

In case of $B_{RPS} < B < B_{OPS}$ at the time when t_{PON} is passed after rising of V_{DD} , this IC maintains the initial output voltage.

Product with S pole detection and active "L"

Product with S pole detection and active "H"



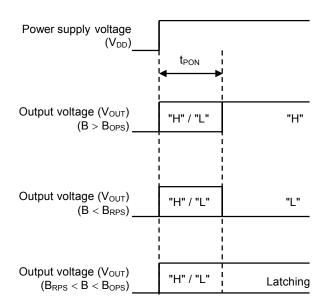


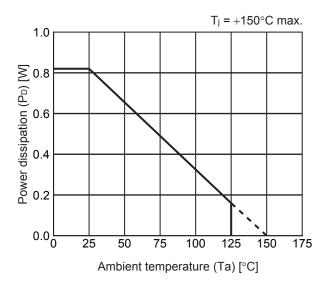
Figure 15

■ Precautions

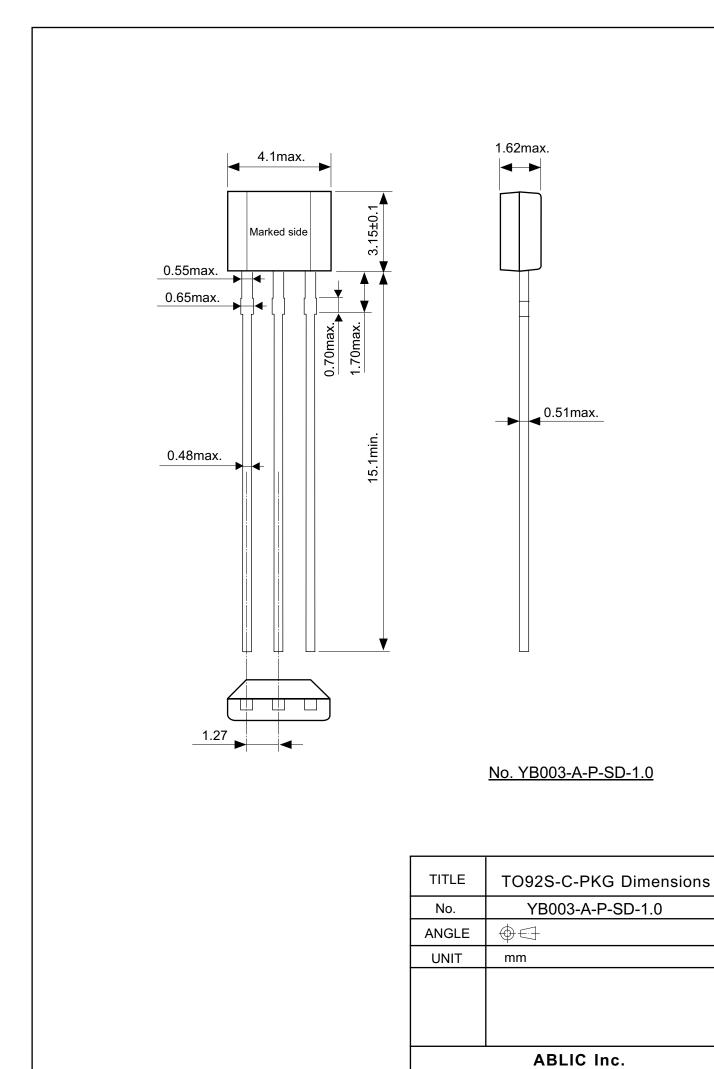
- If the impedance of the power supply is high, the IC may malfunction due to a supply voltage drop caused by feedthrough current. Take care with the pattern wiring to ensure that the impedance of the power supply is low.
- Note that the IC may malfunction if the power supply voltage rapidly changes. When the IC is used under the
 environment where the power supply voltage rapidly changes, it is recommended to judge the output voltage of the IC
 by reading it multiple times.
- Note that the output voltage may rarely change if the magnetic flux density between the operation point and the release point is applied to this IC continuously for a long time.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- Although this IC has a built-in output current limit circuit, it may suffer physical damage such as product deterioration under the environment where the absolute maximum ratings are exceeded.
- The application conditions for the power supply voltage, the pull-up voltage, and the pull-up resistor should not exceed the power dissipation.
- Large stress on this IC may affect on the magnetic characteristics. Avoid large stress which is caused by the handling during or after mounting the IC on a board.
- ABLIC Inc. claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

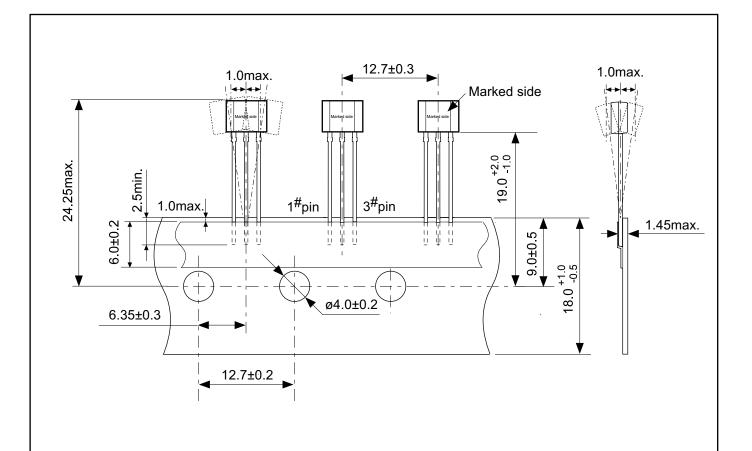
■ Power Dissipation

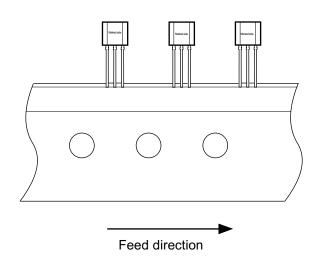
TO-92S



Power Dissipation (P _D)	
0.82 W (when not mounted on board)	

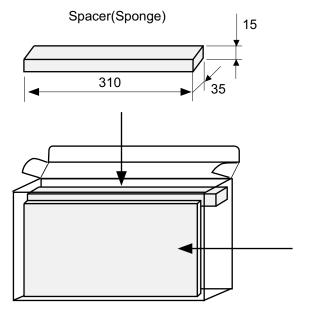




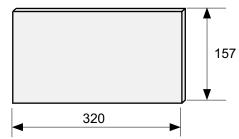


No. YC003-A-C-SD-1.1

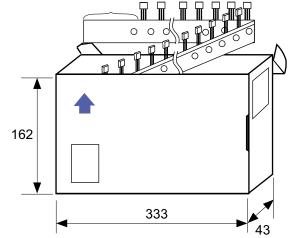
TITLE	TO92S-E-Radial Tape			
No.	YC003-A-C-SD-1.1			
ANGLE				
UNIT	mm			
ABLIC Inc.				



Side spacer placed in front side

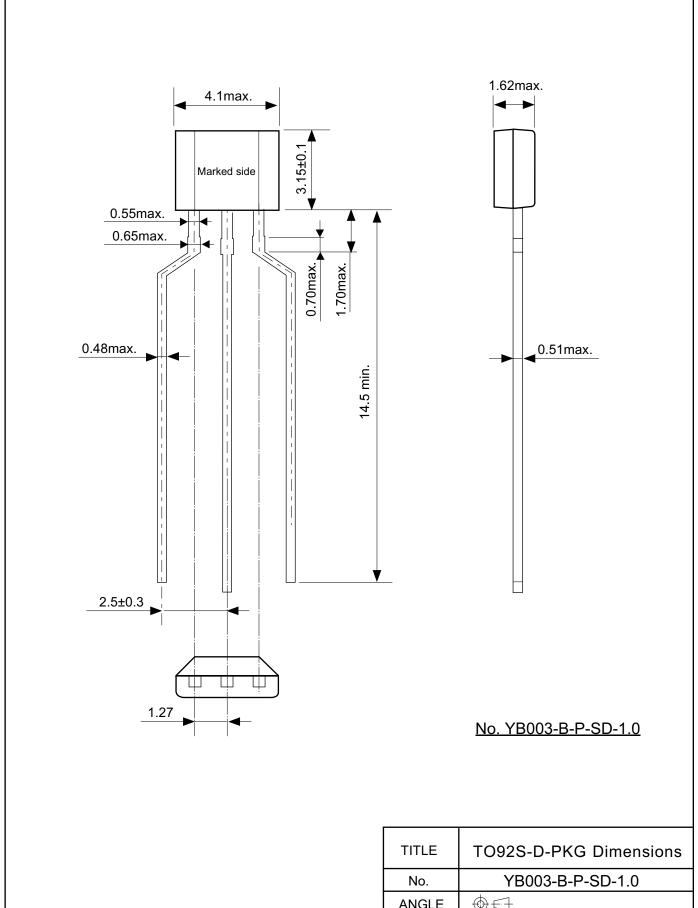


Space more than 4 strokes

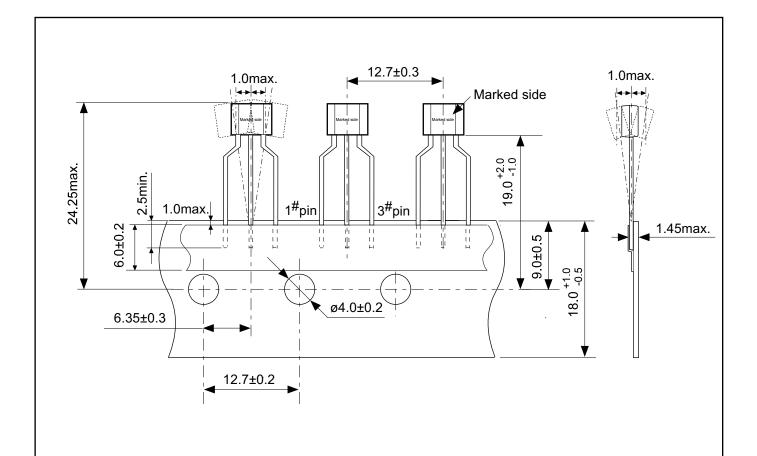


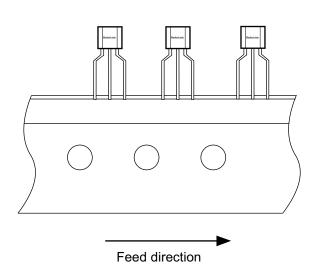
No. YC003-A-Z-SD-1.0

TITLE	TO92S-E-Ammo Packing			
No.	YC00	3-A-Z-SD	-1.0	
ANGLE		QTY.	2,000	
UNIT	mm	-		
ABLIC Inc.				



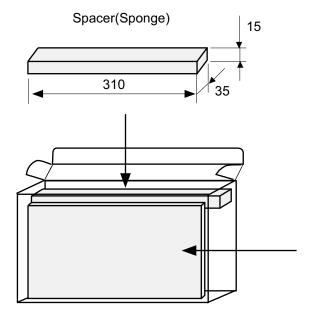
TITLE	TO92S-D-PKG Dimensions			
No.	YB003-B-P-SD-1.0			
ANGLE	\$ =1			
UNIT	mm			
ABLIC Inc.				



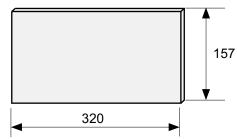


No. YC003-B-C-SD-1.1

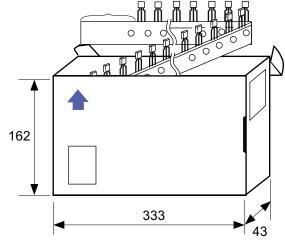
TITLE	TO92S-F-Radial Tape			
No.	YC003-B-C-SD-1.1			
ANGLE				
UNIT	mm			
ABLIC Inc.				



Side spacer placed in front side



Space more than 4 strokes



No. YC003-B-Z-SD-1.0

TITLE	TO92S-F-Ammo Packing				
No.	YC003-B-Z-SD-1.0				
ANGLE		QTY.	2,000		
UNIT	mm	-			
ABLIC Inc.					

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 - The entire system in which the products are used must be sufficiently evaluated and judged whether the products are allowed to apply for the system on customer's own responsibility.
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